LDMOS S-band radar power transistor

Rev. 2 — 23 February 2011

Product data sheet

1. Product profile

1.1 General description

150 W LDMOS power transistor intended for radar applications in the 2.9 GHz to 3.3 GHz range.

Table 1. Typical performance

Typical RF performance at $T_{case} = 25 \ ^{\circ}C$; $t_p = 300 \ \mu$ s; $\delta = 10 \ ^{\circ}$; $I_{Dq} = 100 \ m$ A; in a class-AB production test circuit.

Mode of operation	f	V_{DS}	PL	Gp	η D	t _r	t _f
	(GHz)	(V)	(W)	(dB)	(%)	(ns)	(ns)
pulsed RF	2.9 to 3.3	32	150	13.5	47	20	6

1.2 Features and benefits

- Typical pulsed RF performance at a frequency of 2.9 GHz to 3.3 GHz, a supply voltage of 32 V, an I_{Dq} of 100 mA, a t_p of 300 μs with δ of 10 %:
 - Output power = 150 W
 - Power gain = 13.5 dB
 - Efficiency = 47 %
- Easy power control
- Integrated ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (2.9 GHz to 3.3 GHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

 S-band power amplifiers for radar applications in the 2.9 GHz to 3.3 GHz frequency range



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2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
1	drain		
2	gate		1 لــــا
3	source		2

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information					
Type number	Type number Package				
	Name	Description	Version		
BLS7G2933S-150	-	ceramic earless flanged cavity package; 2 leads	SOT922-1		

4. Limiting values

Table	4.	Limiting	val	lues

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Min	Мах	Unit
drain-source voltage	-	60	V
gate-source voltage	-0.5	+13	V
drain current	-	33	А
storage temperature	-65	+150	°C
junction temperature	-	200	°C
	drain-source voltage gate-source voltage drain current storage temperature	drain-source voltage-gate-source voltage-0.5drain current-storage temperature-65	drain-source voltage-60gate-source voltage-0.5+13drain current-33storage temperature-65+150

5. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
Z _{th(j-mb)}		$T_{case} = 85 \ ^{\circ}C; P_{L} = 150 \ W$		
	to mounting base	t_p = 100 µs; δ = 10 %	0.12	K/W
		t_p = 200 μ s; δ = 10 %	0.14	K/W
		t_p = 300 µs; δ = 10 %	0.16	K/W
		t_p = 500 μ s; δ = 10 %	0.18	K/W
		t_p = 100 µs; δ = 20 %	0.15	K/W

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6. Characteristics

Table 6. $T_j = 25 \ ^{\circ}C$	Characteristics Cunless otherwise specified.					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; \text{ I}_{D} = 0.6 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	$V_{DS} = 10 \text{ V}; I_D = 180 \text{ mA}$	1.5	1.8	2.3	V
I _{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 28 V	-	-	4.2	μA
I _{DSX}	drain cut-off current	$\label{eq:VGS} \begin{array}{l} V_{GS} = V_{GS(th)} + 3.75 \; V; \\ V_{DS} = 10 \; V \end{array}$	29	35	-	A
I _{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	420	nA
g _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 9 \text{ A}$	-	12.7	-	S
R _{DS(on)}	drain-source on-state resistance	$\label{eq:VGS} \begin{array}{l} V_{\mathrm{GS}} = V_{\mathrm{GS(th)}} + 3.75 \; V; \\ I_{\mathrm{D}} = 6.3 \; A \end{array}$	-	0.085	0.135	Ω

7. Application information

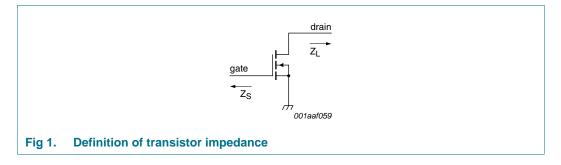
Table 7. Application information

Mode of operation: pulsed RF; $t_p = 300 \ \mu$ s; $\delta = 10 \ \%$; RF performance at $V_{DS} = 32 \ V$; $I_{Dq} = 100 \ m$ A; $T_{case} = 25 \ ^{\circ}C$; unless otherwise specified, in a class-AB production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PL	output power		-	150	-	W
V _{CC}	supply voltage	$P_{L} = 150 W$	-	-	32	V
Gp	power gain	$P_L = 150 W$	11	13.5	-	dB
RL _{in}	input return loss	$P_{L} = 150 W$		-10	-5.5	dB
P _{L(1dB)}	output power at 1 dB gain compression		-	170	-	W
η _D	drain efficiency	$P_{L} = 150 W$	44	47	-	%
Pdroop(pulse)	pulse droop power	$P_{L} = 150 W$	-	0	0.3	dB
t _r	rise time	$P_{L} = 150 W$	-	20	50	ns
t _f	fall time	P _L = 150 W	-	6	50	ns

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Table 8.	Typical impedance		
f	Z _S		ZL
GHz	Ω		Ω
2.9	2.2	– j7.4	4.2 - j6.3
3.0	2.9	– j6.5	3.8 - j6.4
3.1	4.2	– j5.9	3.4 - j6.3
3.2	6.0	– j6.5	2.9 - j6.2
3.3	6.5	– j8.9	2.5 – j5.9

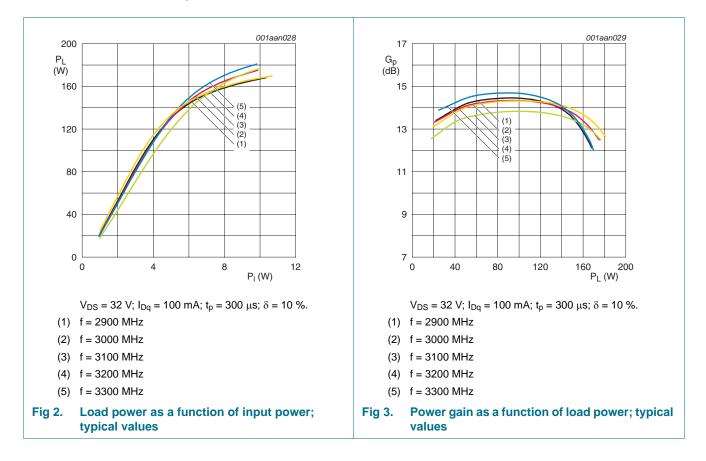


7.1 Ruggedness in class-AB operation

The BLS7G2933S-150 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 100 mA; P_L = 150 W; t_p = 300 µs; δ = 10 %.

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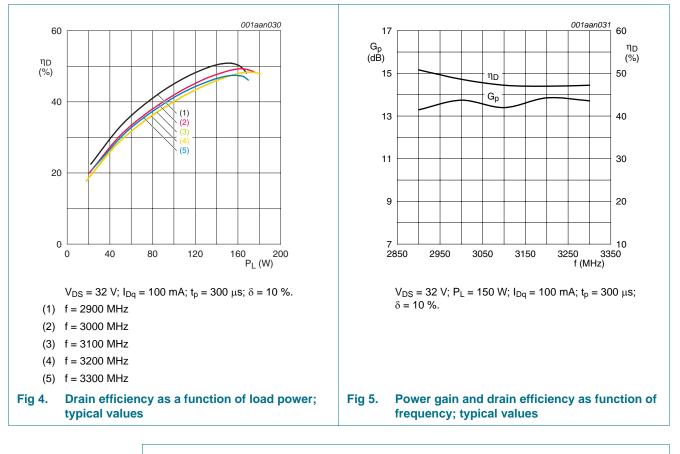
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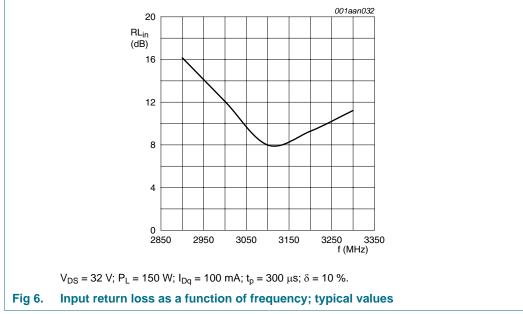


7.2 Graphs

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8. Test information

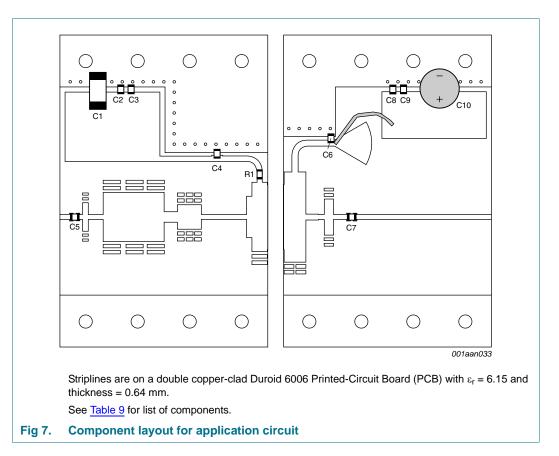


Table 9.List of componentsSee Figure 7.

Gee <u>rigure r</u> .			
Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	10 μF; 20 V	
C2, C8	multilayer ceramic chip capacitor	1 nF	ATC 700A or equivalent
C3, C9	multilayer ceramic chip capacitor	100 pF	ATC 100A or equivalent
C4, C5, C6, C7	multilayer ceramic chip capacitor	10 pF	ATC 100A or equivalent
C10	electrolytic capacitor	68 μF; 63 V	
R1	SMD resistor	10 Ω	SMD 0603

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9. Package outline

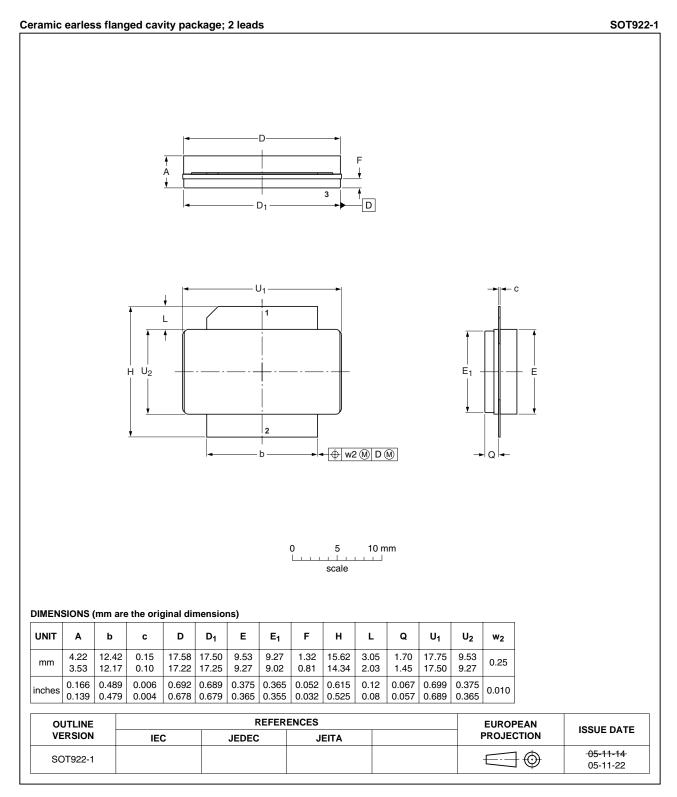


Fig 8. Package outline SOT922-1

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10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

11. Abbreviations

Table 10. Abbre	viations
Acronym	Description
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
RF	Radio Frequency
S-band	Short wave Band
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

12. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLS7G2933S-150 v.2	20110223	Product data sheet	-	BLS7G2933S-150 v.1	
Modifications:	Modifications: • The status of this data sheet has been changed to Product data sheet				
 <u>Table 7 on page 3</u>: Maximum value of RL_{in} has been changed 					
BLS7G2933S-150 v.1	20101112	Objective data sheet	-	-	

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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